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New Trend in Wearable Mobile Machines

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Deadline for manuscript submissions:

closed (20 May 2022)

Message from the Guest Editors

Dear Colleagues,

It is our pleasure to launch this Special Issue and call for original papers that describe recent technological developments in wearable mobile machines. From smart monitoring systems to exoskeletons, wearable devices are being introduced in our daily lives as powerful tools to monitor the user's healthcare and assist us in physically demanding tasks. Contributions from all fields related to the subject are welcome, such as, but not limited to, the following topics:

- Novel wearable mobile machines;
- Novel exoskeleton actuators, passive and active, for healthcare and industry;
- Novel exoskeleton monitoring, benchmark, and control techniques;
- Soft wearable robots and technology;
- Safety and regulatory aspects of wearable technology.

Prof. Dr. Jorge Juan Gil

Prof. Dr. Inaki Diaz

Guest Editors



mdpi.com/si/91863

Special Issue



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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal *Applied Sciences* has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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